**Customer Number: 20277** 

Case Docket Number: 67161-134

## UTILITY PATENT APPLICATION UNDER 37 CFR 1.53(b)

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 Sir:



Transmitted herewith for filing is the patent application of:

INVENTOR: Koyu ASAI, Hiroshi TOBIMATSU, Hiroyuki KAWATA, Mahito

SAWADA

FOR: INTERCONNECTION STRUCTURE OF SEMICONDUCTOR DEVICE

Encl	losed	are:
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$\boxtimes$	15 pages of specification, claims, abstract.
$\boxtimes$	Declaration and Power of Attorney.
$\boxtimes$	Priority Claimed.
	Certified copy of Japanese Patent Application No. 2003-165013(P)
$\boxtimes$	6 sheets of formal drawing.
$\boxtimes$	An assignment of the invention to RENESAS TECHNOLOGY CORP.
	and the assignment recordation fee.
	An associate power of attorney.
	A verified statement to establish small entity status under 37 CFR 1.9 and 37 CFR 1.27.
	Information Disclosure Statement, Form PTO-1449 and references.
$\boxtimes$	Return Receipt Postcard

The filing fee has been calculated as shown below:

	NO. OF CLAIMS		EXTRA CLAIMS	RATE	AMOUNT
Total Claims	6	-20	0	\$18.00	\$0.00
Independent Claims	1	-3	0	\$86.00	\$0.00
Multiple Dependent Claim(s)					\$0.00
Basic Fee					\$770.00
Total of Above Calculations					\$770.00
Less ½ for Small Entity					\$0.00
Assignment & Recording Fee					\$40.00
Total Fee					\$810.00

Any filing fees under 37 CFR 1.16 for presentation of extra claims.

Respectfully submitted,

MCDERMOTT, WILL & EMERY

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Date: December 2, 2003